Γ	1 213 PRODUCT NO PCB THICKNES DIM A 63721-101 1.6 & 2.4 4.19 63721-102 1.6 & 2.4 4.19		6
\bigcirc		5.0 5.0 SEE NOTE 1	4
<u>A</u>			
\bigcirc			2.05+0.05
FG FClconnect.com		SEE TABLE SEE TA	<u>в</u>
\bigcirc	9.5 REF	RECOMMENDED HOLE PATTERN, COMPONENT SIDE.	
-O FCI	 INDICATED HOLES ARE TO BE UNPLATED COMPONENTS SUPPLIED UNASSEMBLED ADD "LF" SUFFIX AT THE END OF PART NUMBER FOR LEAD FREE OPTION. 	HOLE DIAMETER AFTER PLATING0.65 - 0.80DRILLED HOLE0.81 - 0.86 (0.85 DRILL)COPPER PLATING0.025 MINTIN PLATING0.005 - 0.015mat'l codeIsurface	c
Copyright Fi	 (4) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008. 5. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD OR FOR 20 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE. 	mat'l. code surface tolerance projection product family Itr ecn no dr date tolerances unless otherwise specified projection metral. (tm) A V81487 GCR 9/03/98 angles line ar xxx ±.01/.3 MM B V94348 HTB 11/16/99 angles line ar xxx ±.002/.050 scale 1:1 RIGHT ANGLE D M07-0101 MT 2/09/07 dr M. FETROW 7/16/98 FSO dwg no sheet 1 sheet revision D appdC. PENDLETON 9/03/98 FSO 63721 type Product Customer D	f 1 size A3
	form: A3 1 2 3	4 5	6

PDM: Rev:D STATUS Released Printed: Oct 28, 2008